

Filed: Herewith

Title: METHODS FOR FORMING ROUGH RUTHENIUM-CONTAINING LAYERS AND STRUCTURES/METHODS USING SAME

- 8.
- ☒
- The filing fee is calculated below:

CLAIMS AS FILED			
NUMBER FILED	NUMBER EXTRA	RATE	BASIC FEE \$740
Total Claims 23-20 =	3	\$18	\$54
Independent Claims 4-3 =	1	\$84	\$84
MULTIPLE DEPENDENT CLAIM PRESENTED		\$270	\$--
FILING FEE:			\$878

9. ☒ A check in the amount of \$ 878 is attached.
10. ☒ The Commissioner is hereby authorized to charge any additional fees as set forth in 37 CFR §1.16 to 1.18 which may be required by this paper or credit any overpayment to Account No. 13-4895.
11. ☐ This application is being filed by less than all of the inventors named in the prior application. Please delete the names of the following inventor(s) who are not inventors of the invention claimed in the present application:
12. ☒ Amend the specification by inserting as the first sentence on page 1, the following: -- This is a division of application Serial No. 09/589,849, filed 8 June 2000, (pending), which is incorporated herein by reference.--
13. ☐ Priority of foreign application Serial No. , filed on in (country) is claimed under 35 U.S.C. §119.
14. ☒ The prior application is assigned of record to Micron Technology, Inc.
15. ☒ The Power of Attorney in the prior application is to:

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now Patent No. 6,429,127